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(3.80) TYPICAL TAIL LENGTH —HOUSING NOTE 9

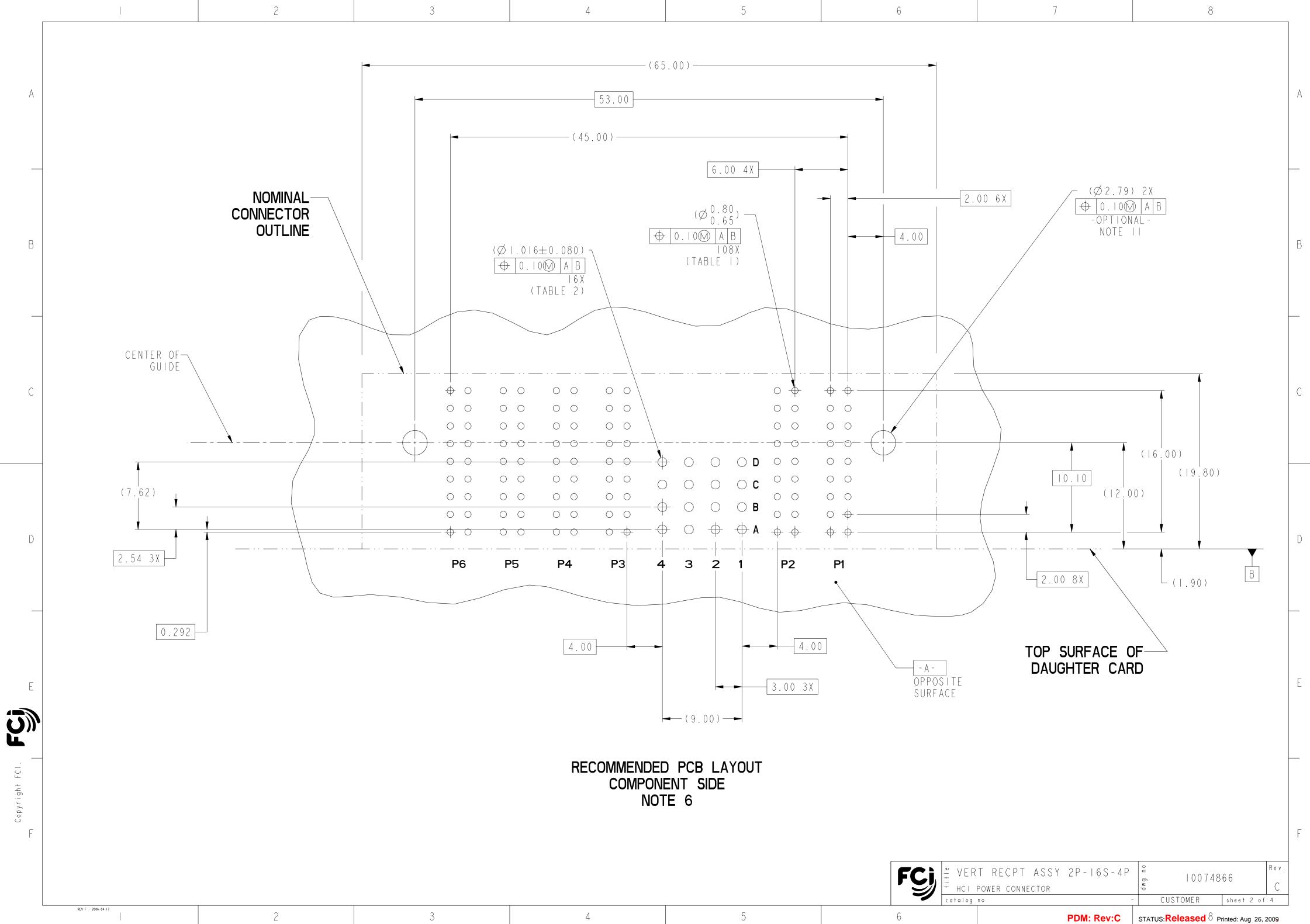
> ◄ (| 9.70) - ----┝━─ (| 2 . 70) ──► (|9.80) (|2,00)L (|.90)

								surfac	e - /	tolera	nce std	projection	MM	
	www.fciconne				nect.com	ASME YI4	. 5 🗸	-	ASME YI4.5					
					TOLERAN	CES UNLESS	OTHERWISE	SPECIFIED						
	Γ		1	Dr	T.HOU	ΤZ	2007-01-08	ANGULAR		0.X	±.3	size	Scale	e
rev	ecn no	dr	date	Eng	H.NGO		2007-01-08	ANGULAR	LINEAR	0.XX	±. 0	1 A 2	3:1	
A	V07-0402	TH	2007-06-13	Chr	H.NGO		2007-01-08	$0^{\circ} \pm 2^{\circ}$		0. X X X	±050	ECN	-	
B	V08-0053	BAB	2008-02-04	Appr	H.NGO		2007-01-08	Produc	t famil'	V	HC I	Spec ref		-
-	V08-0243 -	- -	2008-06-03		(;	÷ VE	RT RECPT			/	0 C	100748	6.6	Rev.
-	-	-	-			т. + НСІ	POWER CONNE	ECTOR			d w g	100740	00	С
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				6				7	PDM: R	ev:C	STATUS: Re	eleased ⁸ P	rinted: Aug 26,	2009

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	I	2	3		4	5		6	
	TOP LAYER			PLAT	TABLE I (HCI F ED THROUGH-HOLE				
	DESCRIPTION	DRILLED HOLE DIAMETER	COPPER THICKNESS	TIN-LEAD THICKNESS	NICKEL THICKNESS	GOLD THICKNESS	TIN THICKNESS	SILVER THICKNESS	FINISHED HOLE DIAMETE
	TIN-LEAD	0.81-0.86 (0.85 DRILL)	0.025 - 0.050	0.005 - 0.015					0.65 - 0.80
	IMMERSION TIN	0.81-0.86 (0.85 DRILL)	0.025 - 0.050				0.9 - I.5um		0.70 - 0.80
		0.81-0.86 (0.85 DRILL)	0.025 - 0.050					0.15 - 0.65um	0.70 - 0.80
	IMMERSION SILVER								
(COPPER (SEE NOTE 9)	0.81-0.86 (0.85 DRILL)	0.025 - 0.050						0.70 - 0.80
(0.025 - 0.050 0.025 - 0.050		0.003 - 0.007	 Flash up to 0.0002			
	COPPER (SEE NOTE 9)	0.81-0.86 (0.85 DRILL)				FLASH UP TO 0.0002 IGNALS)			0.70 - 0.80 0.69 - 0.80
	COPPER (SEE NOTE 9) GOLD	0.81-0.86 (0.85 DRILL)			0.003 - 0.007 TABLE 2 (HPC S	FLASH UP TO 0.0002 IGNALS)			
	COPPER (SEE NOTE 9) GOLD TOP LAYER	0.81-0.86 (0.85 DRILL) 0.81-0.86 (0.85 DRILL) DRILLED HOLE	0.025 - 0.050 COPPER	 PLAT TIN-LEAD	0.003 - 0.007 TABLE 2 (HPC S ED THROUGH-HOLE NICKEL	FLASH UP TO 0.0002 IGNALS) REQUIREMENTS GOLD	 T I N	 SILVER	0.69 - 0.80 FINISHED HOLE DIAMETE 0.94 - 1.10
	COPPER (SEE NOTE 9) GOLD TOP LAYER DESCRIPTION	0.81-0.86 (0.85 DRILL) 0.81-0.86 (0.85 DRILL) DRILLED HOLE DIAMETER 1.125-1.175	0.025 - 0.050 COPPER THICKNESS	 PLAT TIN-LEAD THICKNESS	O.OO3 - O.OO7 TABLE 2 (HPC S ED THROUGH-HOLE NICKEL THICKNESS	FLASH UP TO 0.0002 IGNALS) REQUIREMENTS GOLD THICKNESS	T I N T H I C K N E S S	SILVER THICKNESS	0.69 - 0.80 FINISHED HOLE DIAMETE 0.94 - 1.10
	COPPER (SEE NOTE 9) GOLD TOP LAYER DESCRIPTION TIN-LEAD	0.81-0.86 (0.85 DRILL) 0.81-0.86 (0.85 DRILL) DRILLED HOLE DIAMETER 1.125-1.175	0.025 - 0.050 COPPER THICKNESS	 PLAT TIN-LEAD THICKNESS 0.005-0.015	O.OO3 - O.OO7 TABLE 2 (HPC S ED THROUGH-HOLE NICKEL THICKNESS 	FLASH UP TO 0.0002 IGNALS) REQUIREMENTS GOLD THICKNESS 	T I N T H I C K N E S S	 SILVER THICKNESS 	0.69 - 0.80 FINISHED
	COPPER (SEE NOTE 9) GOLD TOP LAYER DESCRIPTION TIN-LEAD IMMERSION TIN	0.81-0.86 (0.85 DRILL) 0.81-0.86 (0.85 DRILL) DRILLED HOLE DIAMETER 1.125-1.175	0.025 - 0.050 COPPER THICKNESS	 PLAT TIN-LEAD THICKNESS 0.005-0.015 	O.OO3 - O.OO7 TABLE 2 (HPC S ED THROUGH-HOLE NICKEL THICKNESS 	FLASH UP TO 0.0002 IGNALS) REQUIREMENTS GOLD THICKNESS 	 TIN THICKNESS 	 SILVER THICKNESS 	0.69 - 0.80 FINISHED HOLE DIAMETE 0.94 - 1.10

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6			PDM: Rev:C	STAT	rus: Released ⁸ Pi	rinted: Aug 26,	2009
	catalog	no	-		CUSTOMER	sheet 3 of	4
	+ HCI	POWER CONNECTOR		мр			С
FCi	L <mark>⊕</mark> VER	RT RECPT ASSY	2P-16S-4P	g no	100748	66	Rev.

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PART NUMBER	M2.5 SCF NOTE I	R E W	TAIL PLATING		TAIL TYPE			
0074866-00	OPTION	AL	SnPb	PR	ESS-FIT			
10074866-001LF	OPTION	AL	Sn	PR	ESS-FIT			

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NOTES:

2. CONTACT FINISH(ref. GS-12-380 SECTION 5.2)

UL 94V-0 COMPLIANT CONTACTS: HIGH PERFORMANCE COPPER ALLOY

3. PRODUCT SPECIFICATION: GS-12-380.

I. CONNECTOR MATERIALS:

4. APPLICATION SPECIFICATION: GS-20-070.

(5.) PRODUCT MARKING (PRODUCT NUMBER & DATE CODE) ON HOUSING IN AREA SHOWN.

6.) MINIMUM NOMINAL PCB THICKNESS: I.6mm

7. PACKAGING MEETS FCI SPECIFICATION GS-14-1073.

8.) HOUSING COMPONENT WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 60 SECONDS IN A CONVECTION, INFRA-RED, OR VAPOR PHASE REFLOW OVEN.

HOUSING: HIGH TEMPERATURE THERMOPLASTIC, BLACK

(9.) COPPER PLATING THICKNESS IN CENTER OF VIA-HOLE CAN BE NO MORE THAN 0.003 LESS THAN OTHER AREAS.

IO. ALL HOLE SIZES ARE FINISHED HOLE SIZES.

(II) RECOMMENDED RETENTION TO PCB.

Ø 0.110[2.79] THRU HOLE (UNPLATED) FOR M2.5 SELF THREADING SCREW, MAX HEAD Ø 0.177[4.50]. RECOMMENDED SCREW LENGTH 0.276[7.00] + PCB THICKNESS. RECOMMENDED SCREW SEATING TO PCB TORQUE: 2-5 lbf-in (2300-5760 gf-cm).

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